



#3 election
M. Braunson
8/21/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Taylor R. Efland et al. Art Unit: 2814
Serial No.: 09/917,419 Examiner: Phat X. Cao
Filed: 07/30/01 Docket: TI-31306
For: **INTEGRATED POWER CIRCUITS WITH DISTRIBUTED BONDING
AND CURRENT FLOW**

VIA USPS EXPRESS MAIL
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Commissioner of Patents
and Trademarks
Washington, D.C. 20231

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ELECTION

Sir:

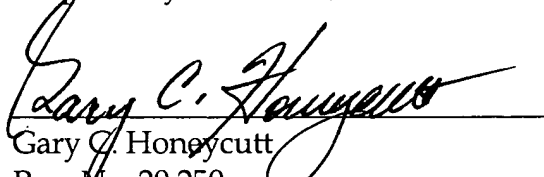
Responsive to the Office Action dated July 23, 2002, please enter the following:

For prosecution, Applicants elect Group I, Claims 1-26, drawn to a semiconductor device, classified in class 257, subclass 784.

Applicants acknowledge that Claims 27-29 are withdrawn from further examination.

A prompt action on the merits is respectfully requested.

Respectfully submitted,


Gary C. Honeycutt
Reg. No. 20,250
Attorneys for Applicant

Dated: August 9, 2002

Godwin Gruber, P.C.
Renaissance Tower
1201 Elm Street, Suite 1700
Dallas, Texas 75270-2084
Phone (214) 939-8651
Fax (214) 760-7332

G O D W I N R U B E R

08/12/02

2814



GARY C. HONEYCUTT
Direct Dial: 214.939.8651
ghoneycutt@godwingruber.com

Attorneys
A Professional Corporation
Renaissance Tower
1201 Elm Street, Suite 1700
Dallas, Texas 75270
214.939.4400
214.760.7332 Fax

godwingruber.com

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Re: Patent Application for:
"Integrated Circuits with Distributed Bonding and Current Flow"
Serial No.: 09/917,419
Attorney Docket: TI-31306
Our File: 50000.2145

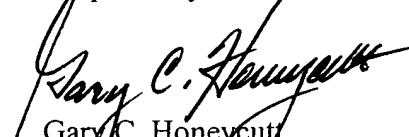
Dear Sir:

Enclosed for filing please find the following items relating to the above-identified application:

- (1) Election Document; and
- (2) Postcards.

Please file the above documents and return the date-stamped postcards to the corresponding addresses, as indicated. In the meantime, if you have any questions or comments concerning this matter, please call the undersigned. Otherwise, please accept the enclosed.

Respectfully submitted,


Gary C. Honeycutt
Reg. No. 20,250

GCH:glc
Enclosures
cc: James Brady, III (Texas Instruments, w/ encls.)